

RoHS

COMPLIANT

VBE1101N Datasheet

N-Channel100-V(D-S)MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)			
100	0.0085 at V _{GS} = 10 V	85			
	0.0105 at V _{GS} = 4.5 V	70			

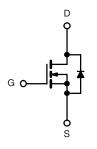
FEATURES

- Trench Power MOSFET
- 100 % R^g Tested
- 100 % UIS Tested

APPLICATIONS

- Primary Side Switch
- Isolated DC/DC Converter





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \degree C$, unless otherwise noted						
Parameter			Limit	Unit		
Drain-Source Voltage			100	V		
Gate-Source Voltage			± 20	v		
Continuous Drain Current (T _J = 150 °C)	T _C = 25 °C	I _D	85			
	T _C = 125 °C		75 ^a			
Pulsed Drain Current	I _{DM}	300	A			
Avalanche Current	L = 0.1 mH	I _{AS}	75			
Single Pulse Avalanche Energy ^b	L = 0.1 mm	E _{AS}	280	mJ		
Maximum Power Dissipation ^b	T _C = 25 °C	PD	176	w		
	T _A = 25 °C	'D	3.75			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	40	50	°C/W	
Maximum Junction-to-Case	Sleady Slale	R _{thJC}	0.85	1.1	0/10	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		·					
Drain-Source Breakdown Voltage	V _{DS}					V	
Gate-Threshold Voltage	V _{GS(th)}				4		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = 100 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50	μA	
		$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175^{\circ}\text{C}$		250			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	50			А	
		V _{GS} = 10 V, I _D = 20 A	0.0085				
	P	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0105			
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D =20 A, T _J = 125 °C		0.017		Ω	
		V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.022			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20A	25			S	
Dynamic ^b	-			•			
Input Capacitance	C _{iss}			4000		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz$		565			
Reverse Transfer Capacitance	C _{rss}	7		205			
Total Gate Charge ^c	Qg			105	160	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 45 \text{ A}$		17			
Gate-Drain Charge ^c	Q _{gd}	1		23			
Turn-On Delay Time ^c	t _{d(on)}			12	25		
Rise Time ^c	t _r	V_{DD} = 20 V, R_L = 0.6 Ω		90	135		
Turn-Off DelayTime ^c	t _{d(off)}	$\text{I}_\text{D} \cong$ 45 A, V_GEN = 10 V, R_g = 2.5 Ω		55	85	ns	
Fall Time ^c	t _f	1		130	195		
Source-Drain Diode Ratings and Cha	racteristics T _C	= 25 °C ^b					
Continuous Current	ا _S				85	٨	
Pulsed Current	I _{SM}				140	A	
Forward Voltage ^a	V _{SD}	$I_{F} = 45 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			85	140	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, dI/dt = 100 A/μs		4.5	7	Α	
Reverse Recovery Charge	Q _{rr}	1		0.17	0.35	μC	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

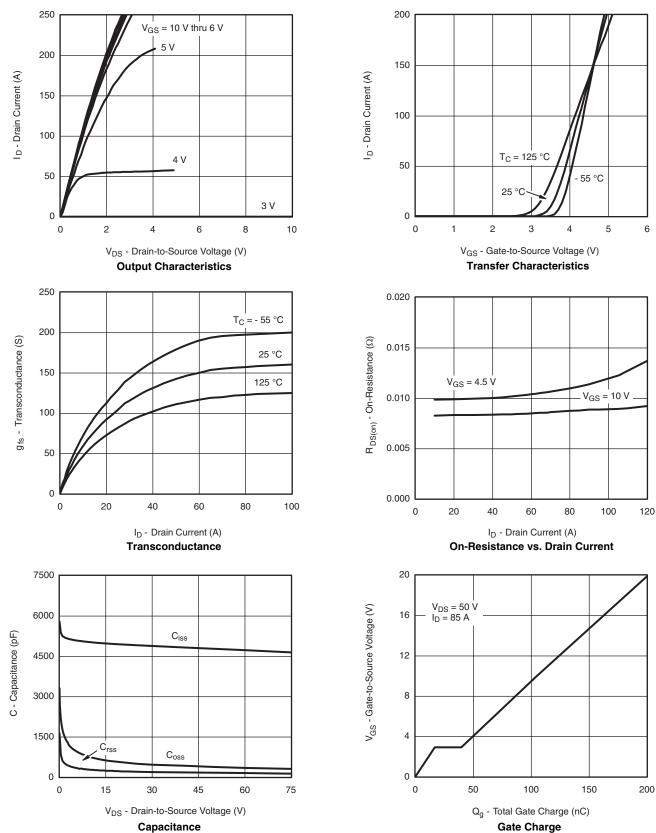
b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

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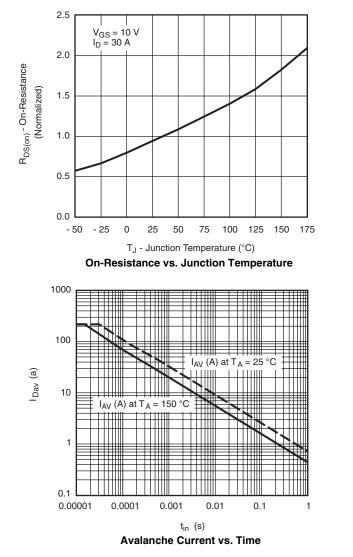


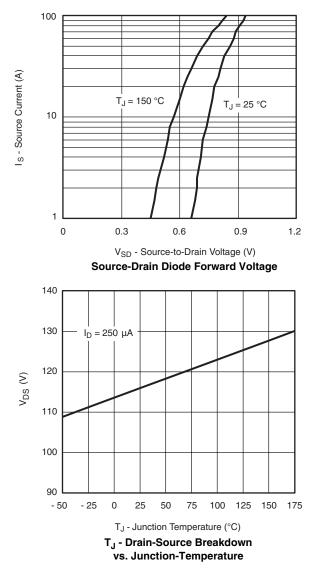
TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted





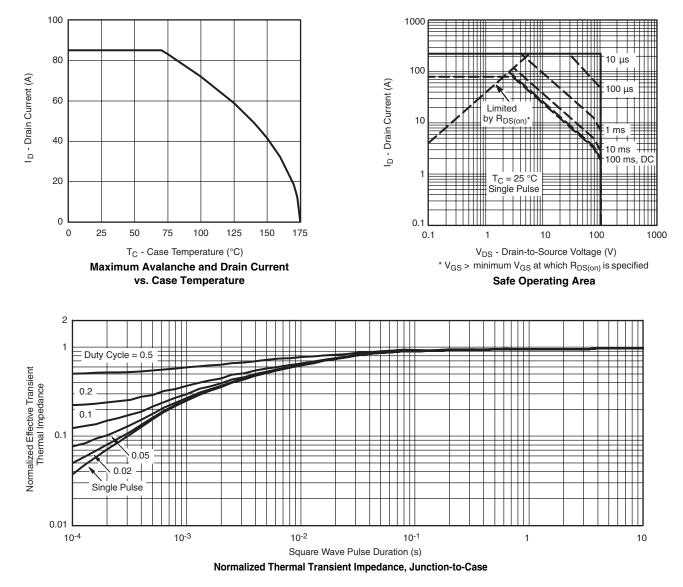
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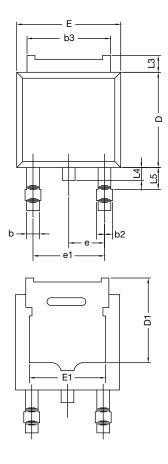


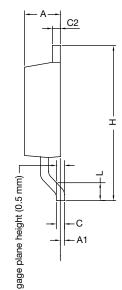
THERMAL RATINGS





TO-252AA CASE OUTLINE





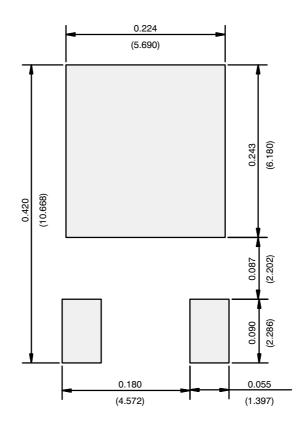
	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	BSC	0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347					

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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